

# **Cree® XLamp® XB-E High-Voltage White LEDs**



# **PRODUCT DESCRIPTION**

Built on Cree's SC<sup>3</sup> Technology® Platform, the XLamp® XB-E High-Voltage White (HVW) LED is optimized to lower cost for high-lumen, omnidirectional replacement lamps. The XB-E HVW LED delivers high efficacy in the small XB footprint and enables smaller and more efficient driver circuits than standard-voltage LEDs. In addition, the XB-E LED has a wider light distribution that can improve the omnidirectionality of ENERGY STAR® replacement lamps.

# **FEATURES**

•	Binned	@	85	°C	&	44n	nΑ	١

- · Available in 80-minimum CRI
- 125 mA maximum drive current
- 23.5 V typical forward voltage
  @ 85 °C, 44 mA
- Wide viewing angle: 140°
- Reflow solderable JEDEC J-STD-020C compatible
- Unlimited floor life at
  ≤ 30 °C/85% RH
- · Electrically neutral thermal path
- · RoHS and REACh compliant
- UL®-recognized component (E349212)



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# **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		6.5	
Viewing angle (FWHM)	degrees		140	
Temperature coefficient of voltage	mV/°C		-19	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			125
Reverse voltage	V			0.1
Forward voltage (@ 44 mA, 85 °C)	V		23.5	26.5
LED junction temperature	°C			150

# FLUX CHARACTERISTICS (T<sub>1</sub> = 85 °C)

The following table provides several base order codes for XLamp XB-E HVW LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB LED Family Binning and Labeling document.

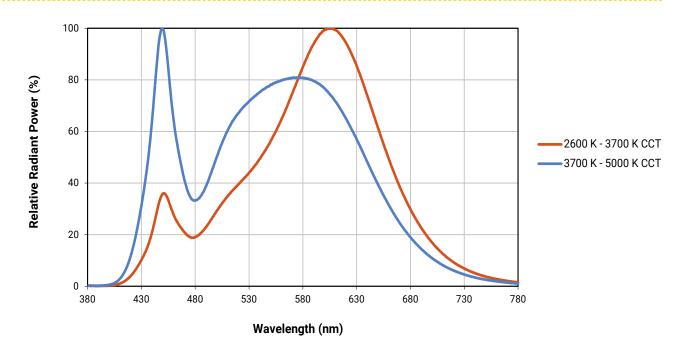
Color	CCT Range		Minimum Luminous Flux @ 44 mA			Calculated Minimum Luminous Flux (Im)**		Order Code	
Color	Minimum	Maximum	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	66 mA	100 mA	Order Code	
	4750 K	5000 K	R3	122	140	171	236	XBEHVW-H0-0000-00000HFE3	
OO CDI Minimouro			R2	114	131	160	221	XBEHVW-H0-0000-00000HEE3	
80 CRI Minimum	2700 K 3000	2000 K	Q4	100	118	140	194	XBEHVW-H0-0000-00000HCE7	
		3000 K	Q3	93.9	108	132	182	XBEHVW-H0-0000-00000HBE7	

#### Notes:

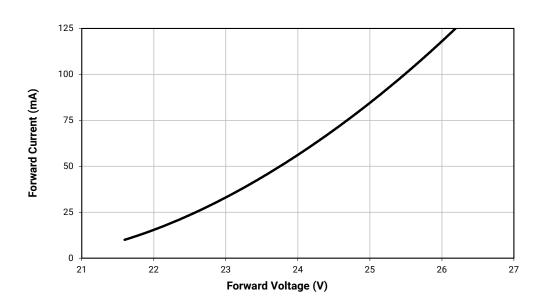
- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 7).
- Minimum CRI for 80 CRI Minimum is 80.
- \* Flux values @ 25 °C are calculated and are for reference only.
- \*\* Calculated flux values at 66 mA and 100 mA are for 85 °C and are for reference only.



# **RELATIVE SPECTRAL POWER DISTRIBUTION**

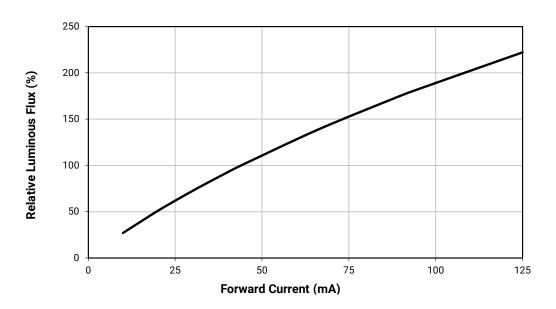


# **ELECTRICAL CHARACTERISTICS (T, = 85 °C)**

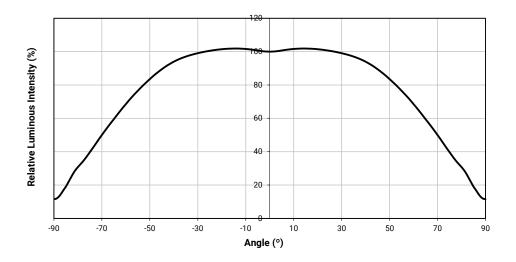




# RELATIVE FLUX VS. CURRENT (T, = 85 °C)



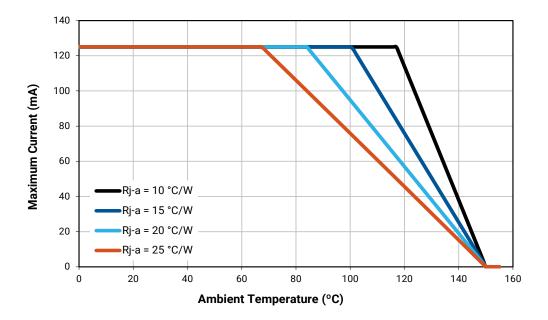
# TYPICAL SPATIAL DISTRIBUTION





# THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

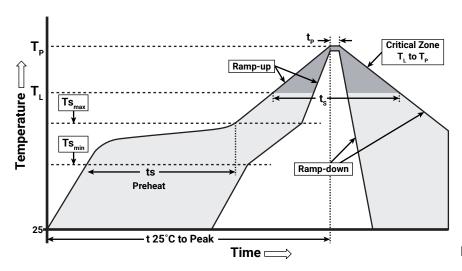




# **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XB-E HVW LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder		
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	1.2 °C/second		
Preheat: Temperature Min (Ts <sub>min</sub> )	120 °C		
Preheat: Temperature Max (Ts <sub>max</sub> )	170 °C		
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	65-150 seconds		
Time Maintained Above: Temperature (T <sub>L</sub> )	217 °C		
Time Maintained Above: Time (t <sub>L</sub> )	45-90 seconds		
Peak/Classification Temperature (Tp)	235 - 245 °C		
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds		
Ramp-Down Rate	1 - 6 °C/second		
Time 25 °C to Peak Temperature	4 minutes max.		

Note: All temperatures refer to the topside of the package, measured on the package body surface.



#### **NOTES**

#### Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

# **Pre-Release Qualification Testing**

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

#### **Lumen Maintenance**

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

# **Moisture Sensitivity**

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XB-E HVW LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq$  30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

# **REACh Compliance**

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.



# **NOTES - CONTINUED**

# **UL® Recognized Component**

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.

# **Vision Advisory**

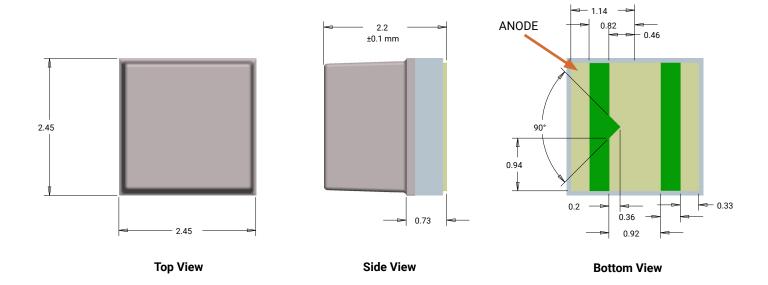
WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

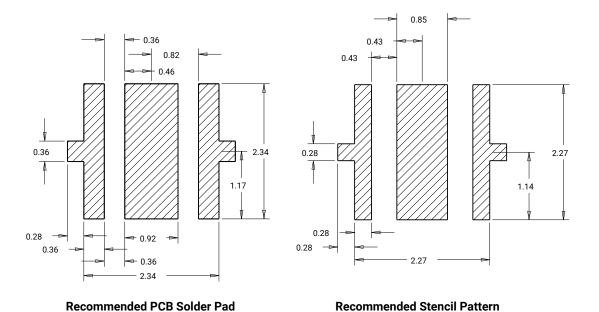


# **MECHANICAL DIMENSIONS**

Thermal vias, if present, are not shown on these drawings.

All measurements are ±.13 mm unless otherwise indicated.



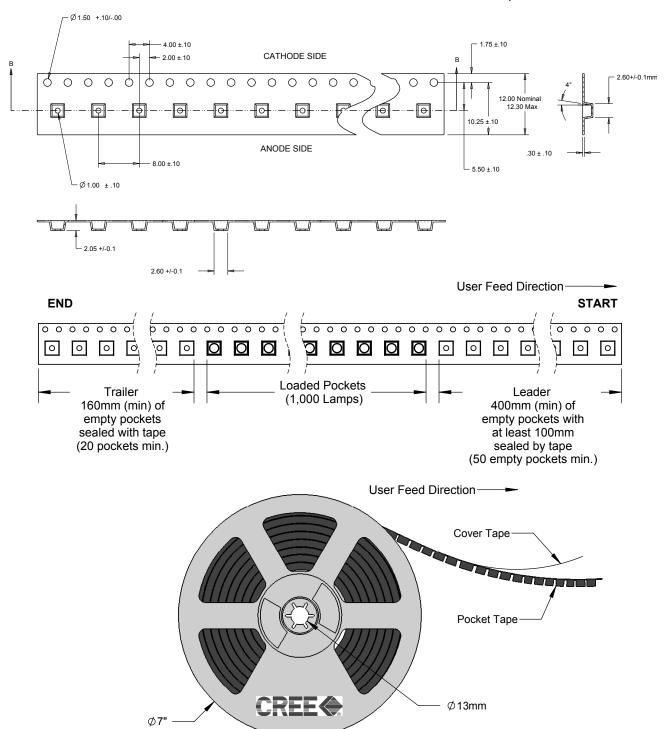




#### **TAPE AND REEL**

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Unless otherwise indicated, all dimensions in mm Tolerance unless specified: .xx ±.25, .xx ±.125, x° ± 5°





# **PACKAGING**

# Label with Cree Bin Code, Quantity, Reel ID

